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#### **40V PNP MEDIUM POWER TRANSISTOR IN SOT223**

### **Features**

- $BV_{CEO} > -40V$
- I<sub>C</sub> = -3A High Continuous Current
- I<sub>CM</sub> = -6A Peak Pulse Current
- Very Low Equivalent On-Resistance;  $R_{CE}(sat)$  125m $\Omega$  at 2A
- h<sub>FE</sub> of 200 at I<sub>C</sub>=1A and Very Low Saturation Voltage
- Complementary NPN Type: FZT690B
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Applications**

- DC-DC Converters
- Siren Drivers

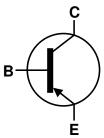
### **Mechanical Data**

- Case: SOT223
- Case material: Molded Plastic. "Green" Molding Compound; UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.112 grams (Approximate)

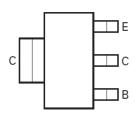
# SOT223



Top View



Device Symbol



Top View Pin-Out

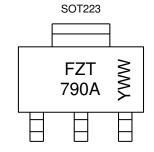
### Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FZT790ATA	FZT790A	7	12	1,000

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**



FZT 790A = Product Type Marking Code YWW = Date Code Marking Y or  $\overline{Y}$  = Last Digit of Year (ex: 5= 2015) WW or  $\overline{W}W = \text{Week Code } (01 \sim 53)$ 





March 2015

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### Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	-50	V
Collector-Emitter Voltage	$V_{CEO}$	-40	V
Emitter-Base Voltage	$V_{EBO}$	-7	V
Continuous Collector Current	Ic	-3	Α
Peak Pulse Current	I <sub>CM</sub>	-6	Α

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
	(Note 5)		3.0		
Rower Discipation	(Note 6)	D-	2.0	W	
Power Dissipation	(Note 7)		1.6	VV	
	(Note 8)		1.2		
	(Note 5)		41.7		
Thermal Resistance, Junction to Ambient	(Note 6)	В	62.5	°C/W	
Thermal nesistance, Junction to Ambient	(Note 7)	$R_{ hetaJA}$	78.1		
	(Note 8)		104	1	
Thermal Resistance Junction to Lead (Note 9)		$R_{ hetaJL}$	12.9		
Operating and Storage Temperature Range	$T_{J}, T_{STG}$	-55 to +150	°C		

### ESD Ratings (Note 10)

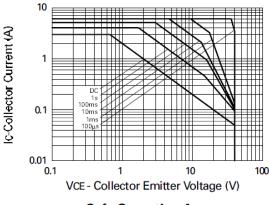
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

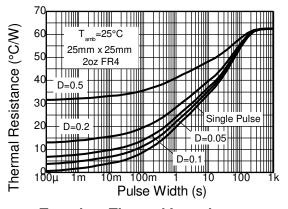
- 5. For a device mounted with the collector lead on 50mm x 50mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 6. Same as Note 5, except the device is mounted on 25mm x 25mm 2oz copper.
- 7. Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper.
- 8. Same as Note 5, except the device is mounted on minimum recommended pad layout.
- 9. Thermal resistance from junction to solder-point (at the end of the collector lead).

  10. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

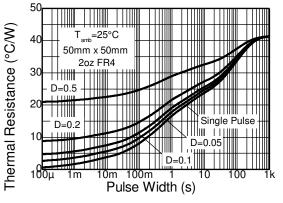
### **Thermal Characteristics and Derating Information**



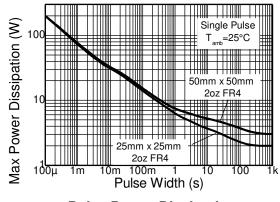
Safe Operating Area



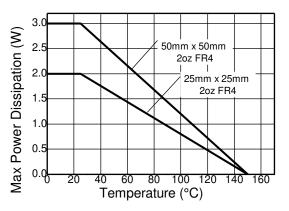
**Transient Thermal Impedance** 



**Transient Thermal Impedance** 



**Pulse Power Dissipation** 



**Derating Curve** 





FZT790A

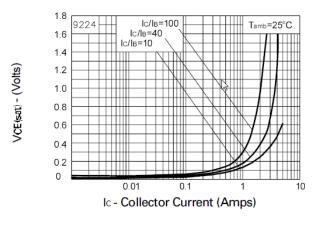
### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур.	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-50	-70	-	V	$I_{C} = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 11)	$BV_CEO$	-40	-60	-	٧	$I_C = -10mA$
Emitter-Base Breakdown Voltage	$BV_{EBO}$	-7	-8.5	-	V	$I_E = -100 \mu A$
Collector Cut-Off Current	I <sub>CBO</sub>	-	-	-0.1 -10	μА	V <sub>CB</sub> = -30V V <sub>CB</sub> = -30V, T <sub>A</sub> = +100°C
Emitter Cut-Off Current	I <sub>EBO</sub>	-	-	-0.1	μΑ	V <sub>EB</sub> = -4V
		300	-	800	-	$I_C = -10 \text{mA}, V_{CE} = -2 \text{V}$
DC Current Transfer Static Patic (Note 11)	h	250	-	-		$I_C = -500 \text{mA}, V_{CE} = -2V$
DC Current Transfer Static Ratio (Note 11)	h <sub>FE</sub>	200	-	-		$I_C = -1A$ , $V_{CE} = -2V$
		150	-	-		$I_C = -2A$ , $V_{CE} = -2V$
		-	-0.15	-0.25	V	$I_C = -500 \text{mA}, I_B = -5 \text{mA}$
Collector-Emitter Saturation Voltage (Note 11)	V <sub>CE(sat)</sub>	-	-0.30	-0.45		$I_C = -1A$ , $I_B = -10mA$
		-	-0.40	-0.75		$I_C = -2A$ , $I_B = -50mA$
Base-Emitter Saturation Voltage (Note 11)	V <sub>BE(sat)</sub>	-	-0.8	-1.0	V	$I_C = -1A$ , $I_B = -10mA$
Base-Emitter Turn-On Voltage (Note 11)	V <sub>BE(on)</sub>	-	-0.75	-	V	I <sub>C</sub> = -1A, V <sub>CE</sub> = -2V
Transitional Frequency	f <sub>T</sub>	100	-	-	MHz	$I_C = -50 \text{mA}, V_{CE} = -5 \text{V},$ f = 50 MHz
Output Capacitance	C <sub>obo</sub>	-	24	-	pF	V <sub>CB</sub> = -10V, f = 1MHz
Switching Time	t <sub>ON</sub>	-	35	-	no	$V_{CC} = -10V, I_{C} = -500mA,$
Switching Time	toff	-	600	-	ns	$I_{B1} = -I_{B2} = -50 \text{mA}$

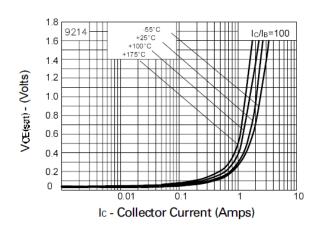
Note: 11. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$  2%.

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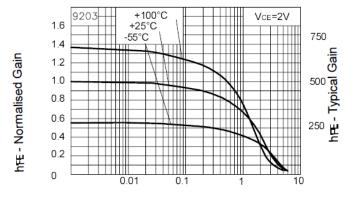
### Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)



VCE(sat) v IC

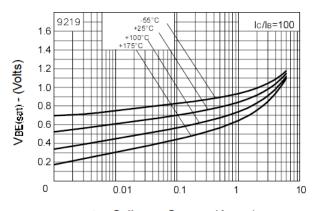


VCE(sat) v IC



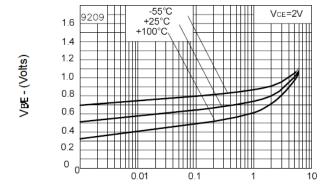
Ic - Collector Current (Amps)





Ic - Collector Current (Amps)

### VBE(sat) v IC



Ic - Collector Current (Amps)

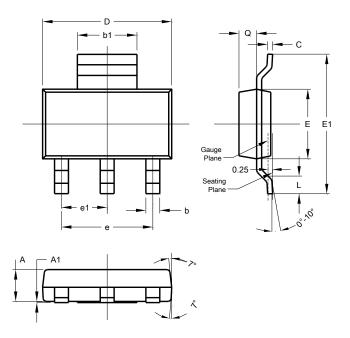
VBE(on) v IC

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March 2015

### **Package Outline Dimensions**

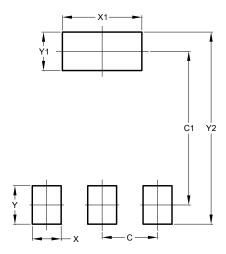
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
<b>A</b> 1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	-	-	4.60		
e1	-	-	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

### **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.30
C1	6.40
Х	1.20
X1	3.30
Υ	1.60
Y1	1.60
Y2	8.00





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